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HIGH VOLTAGE POWER SCHOTTKY RECTIFIER

Product Summary

V _{RRM} (V)	I _O (A)	V _{F (MAX)} (V) @ +25°C	I _{R (MAX)} (mA) @ +25°C
200	5	0.95	0.5

Description

High voltage schottky rectifier suited for switch mode power supplies and other power converters. This device is intended for use in medium voltage operation, and particularly, in high frequency circuits where low switching losses and low noise are required.

The MBR5200 is available in standard DO-27, DO-27 (C) and DO-27 (Type YJ) packages.

Applications

- Power Supply-Output Rectification
- Power Management
- Instrumentation

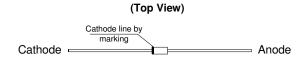
Features

- Low Forward Voltage: 0.95V @ +25°C
- High Surge Current Capacity
- +150°C Operating Junction Temperature
- 5A Total
- Guard-Ring for Stress Protection
- Pb-free Package is Available
- DO-27, DO-27 (C) and DO-27 (Type YJ)
 - Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Available in "Green" Packages: DO-27
 - Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
 - Halogen and Antimony Free. "Green" Device (Note 3)

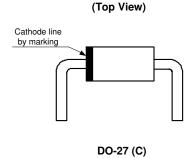
Mechanical Data

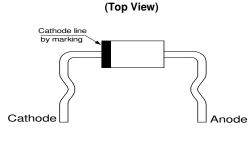
- Case: DO-27, DO-27 (C), DO-27 (Type YJ)
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 (3)
- Weight (Approximately): 1.13Grams

Pin Assignments



DO-27





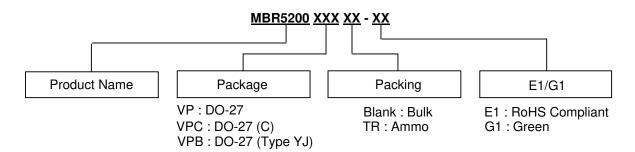
DO-27 (Type YJ)

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



Ordering Information





Package	Part Number	Marking ID	Packing
DO-27	MBR5200VP-E1	5200VP	500 Pieces/Bulk
DO-27	MBR5200VP-G1	520VPG	500 Pieces/Bulk
DO-27	MBR5200VPTR-E1	5200VP	500 Pieces/Ammo
DO-27	MBR5200VPTR-G1	520VPG	500 Pieces/Ammo
DO-27 (Type YJ)	MBR5200VPBTR-E1	5200VPB	500 Pieces/Ammo
DO-27 (C)	MBR5200VPC-E1	5200VPC	500 Pieces/Bulk

Marking Information

(1) DO-27



First Line: Logo and Date Code Y: Year WW: Work Week of Molding A: Assembly House Code Second Line: Marking ID (See Ordering Information)



Marking Information (Cont.)

(2) DO-27 (C), DO-27 (Type YJ)



First Line: Logo and Date Code Y: Year WW: Work Week of Molding A: Assembly House Code Second Line: Marking ID (See Ordering Information)

Maximum Ratings (Per Diode Leg) (Note 4)

Characteristic	Symbol	Rating	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	200	V
Average Rectified Forward Current (Rated V_R) $T_C = TBD$	I _{F(AV)}	5	А
Non Repetitive Peak Surge Current (Surge Applied at Rated Load Conditions Half Wave, Single Phase, 60Hz)	I _{FSM}	100	А
Operating Junction Temperature Range (Note 5)	TJ	-65 to +150	°C
Storage Temperature Range	T _{STG}	-65 to +150	°C
Voltage Rate of Change (Rated V _R)	dv/dt	10000	V/µs
ESD (Machine Model = C)	_	400	V
ESD (Human Body Model = 3B)	_	8000	V

Notes:

- 4. Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.
- 5. The heat generated must be less than the thermal conductivity from Junction to Ambient: $dP_D/dT_J < 1/\theta_{JA}$.



Thermal Characteristics

Characteristic	Symbol	Rating	Unit	
Maximum Thermal Resistance (Junction to Case)	Rejc	5	°C/W	
Maximum Thermal Resistance (Junction to Ambient)	$R_{\theta JA}$	30		

Electrical Characteristics

Characteristic	Symbol	Rating	Unit	Test Condition
	VF	0.95	V	$I_F = 5A$, $T_C = +25$ °C
Maximum Instantaneous Forward Voltage Drop (Note 6)		0.75		I _F = 5A, T _C = +125°C
Mariana la tarta de Para Coment (Nata C)	I _R	0.5	mA	Rated DC Voltage, T _C = +25°C
Maximum Instantaneous Reverse Current (Note 6)		1.0		Rated DC Voltage, T _C = +125°C

Note 6: Short duration pulse test used to minimize self-heating effect, Pulse Test: Pulse Width = 300µs, Duty Cycle ≤ 2.0%.

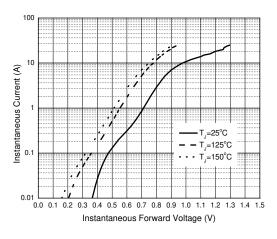


Figure 1. Typical Forward Characteristics

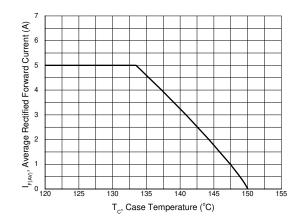


Figure 3. Average Rectified Forward Current vs.

Case Temperature

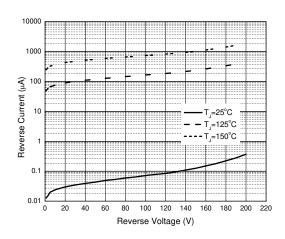


Figure 2. Typical Reverse Characteristics

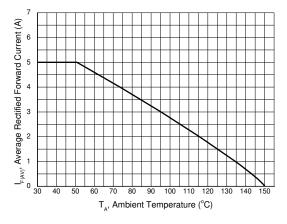


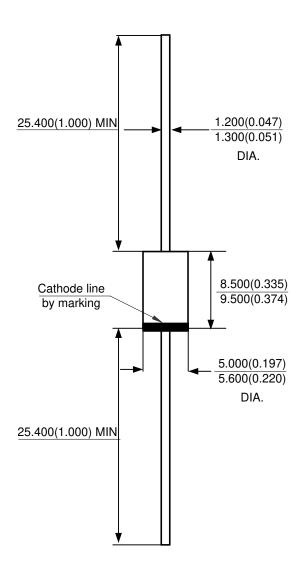
Figure 4. Average Rectified Forward Current vs.

Ambient Temperature



Package Outline Dimensions (All dimensions in mm(inch).)

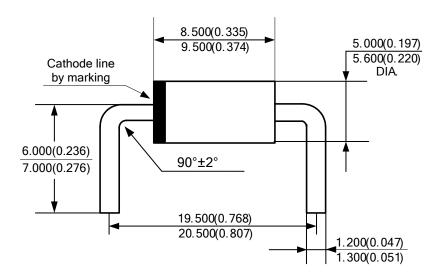
(1) Package Type: DO-27

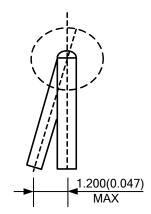




Package Outline Dimensions (Cont. All dimensions in mm(inch).)

(2) Package Type: DO-27 (C)



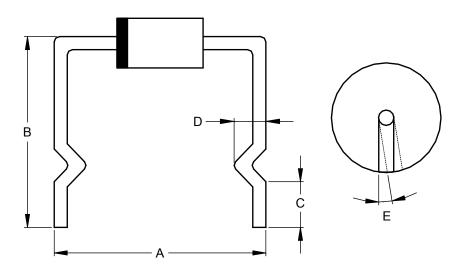




Package Outline Dimensions (Cont.)

Please see http://www.diodes.com/package-outlines.html for the latest version.

(3) Package Type: DO-27 (Type YJ)



DO-27 (Type YJ)			
Dim	Min	Max	Тур
Α	16.17	16.27	16.22
В	14.11	15.11	14.61
С	3.00	4.00	3.50
D	2.3		
E	0°	1.5°	
All Dimensions in mm			



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